

MOSFET

StrongIRFET™ 2 Power-Transistor, 30 V

Features

- Optimized for a wide range of applications
- N-channel, logic level
- 100% avalanche tested
- 175°C rated
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

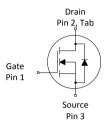
Product validation

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

- indice - included in a more con-								
Parameter		Value		Unit				
$V_{ m DS}$		30		V				
$R_{\rm DS(on),max}$		3.3		mΩ				
I _D		78		А				
Qoss		26		nC				
Q _G (0V4.5V)		16		nC				









Type/Ordering Code	Package	Marking	Related Links
IPP033N03LF2S	PG-TO220-3	033N03F2	-

Public

StronglRFET™ 2 Power-Transistor, 30 V IPP033N03LF2S



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StrongIRFET™ 2 Power-Transistor, 30 V IPP033N03LF2S



1 Maximum ratings

unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Syllibot	Min.	Тур.	Max.	Offic	Note/ Test Condition
Continuous drain current ¹⁾	I_{D}	-	-	78 60 25	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	312	А	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	109 219	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω $I_{\rm D}$ =25 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P_{tot}	-	-	83 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

StrongIRFET™ 2 Power-Transistor, 30 V IPP033N03LF2S



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Nieto/Test Condition
raiametei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	1.8	°C/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	_	_	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.



3 Electrical characteristics

unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Syllibot	Min.	Тур.	Мах.	Ollic	
Drain-source breakdown voltage	$V_{(BR)DSS}$	30	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =2mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.35	1.85	2.35	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 40 \ \mu A$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =30 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =30 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance ⁶⁾	$R_{\mathrm{DS(on)}}$	-	2.8 3.5	3.3 5.0	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =25 A
Gate resistance	R_{G}	-	2.1	-	Ω	-
Transconductance ⁷⁾	g_{fs}	60	-	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$

⁶⁾ R_{DS(on)} is specified at a distance of 1.8 mm distance to the package body; mounting at a larger distance increases the overall package resistance of approximately 0.04 mOhm/mm per leg.

Table 5 Dynamic characteristics

Darameter	Symbol	Values			Unit	Note/ Test Condition
Parameter	Syllibot	Min.	Тур.	Мах.		Note/ Test Condition
Input capacitance	C _{iss}	-	2200	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance	C_{oss}	-	450	-	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =15 V, f =1 MHz
Reverse transfer capacitance	C _{rss}	-	120	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	16	-	ns	$V_{\rm DD} = 15 \text{ V}, V_{\rm GS} = 4.5 \text{ V}, I_{\rm D} = 50 \text{ A},$ $R_{\rm G,ext} = 1.6 \Omega$
Rise time	t _r	-	48	-	ns	$V_{\rm DD} = 15 \text{ V}, V_{\rm GS} = 4.5 \text{ V}, I_{\rm D} = 50 \text{ A},$ $R_{\rm G,ext} = 1.6 \Omega$
Turn-off delay time	$t_{ m d(off)}$	-	14	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t_{f}	-	8.2	-	ns	$V_{\rm DD} = 15 \text{ V}, V_{\rm GS} = 4.5 \text{ V}, I_{\rm D} = 50 \text{ A},$ $R_{\rm G,ext} = 1.6 \Omega$

Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailietei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Gate to source charge	$Q_{ m gs}$	-	7.7	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	4.0	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	5.1	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V

⁷⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition
Switching charge	Q_{sw}	-	8.6	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ⁹⁾	Q_{g}	-	16	24	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	$V_{ m plateau}$	-	3.4	-	V	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ⁹⁾	Q_{g}	-	33	50	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET ⁹⁾	$Q_{g(sync)}$	-	14	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ⁹⁾	Q _{oss}	-	26	-	nC	$V_{\rm DS}$ =15 V, $V_{\rm GS}$ =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

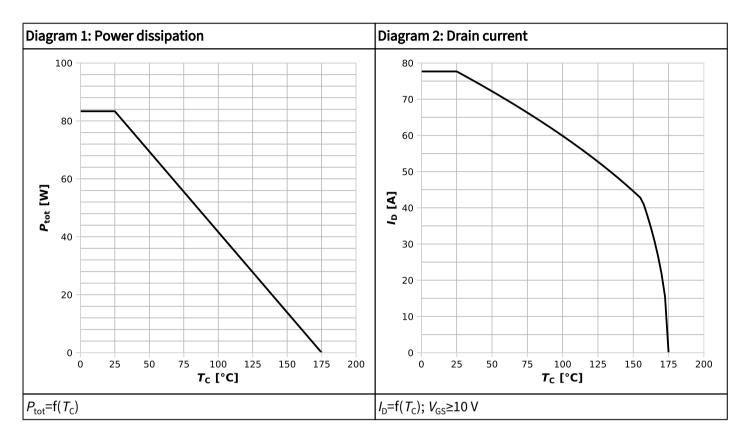
Table 7 Reverse diode

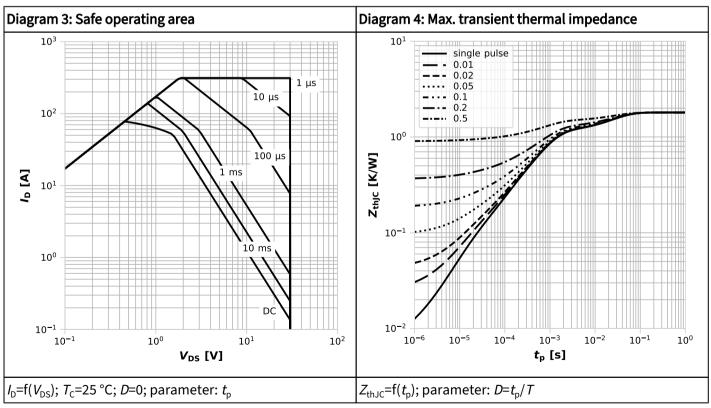
Darameter	Symbol	Values			Unit	Note/ Test Condition
Parameter	Syllibot	Min.	Тур.	Мах.	Ollic	Note/ Test Condition
Diode continuous forward current	Is	-	-	60	А	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	312	А	<i>T</i> _c =25 °C
Diode forward voltage	$V_{\rm SD}$	-	0.86	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C
Reverse recovery time	t _{rr}	-	17	-	ns	$V_{\rm R}$ =15 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =500 A/ μ s
Reverse recovery charge	$Q_{\rm rr}$	-	41	-	nC	$V_{\rm R}$ =15 V, $I_{\rm F}$ =50 A, d $I_{\rm F}$ /d t =500 A/ μ s

⁹⁾ Defined by design. Not subject to production test.

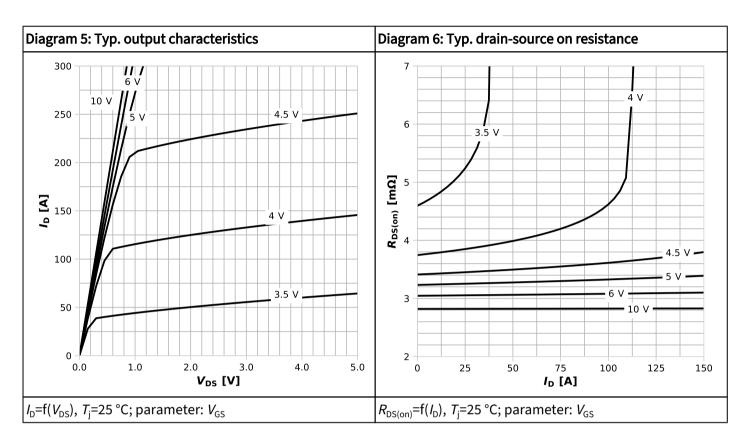


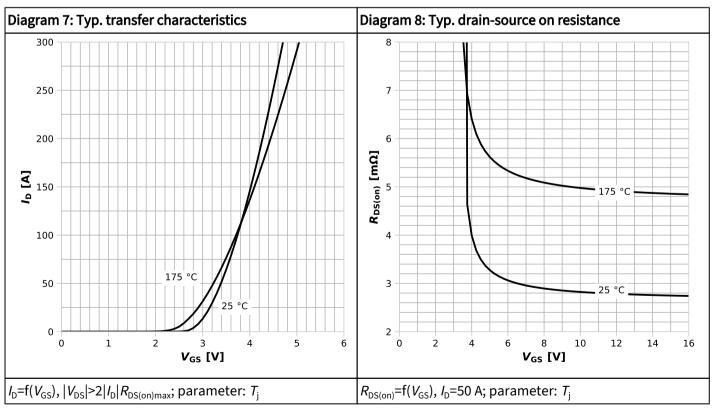
4 Electrical characteristics diagrams



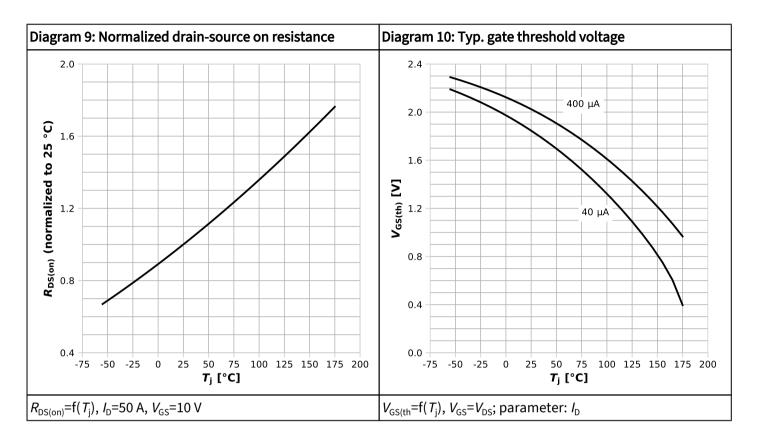


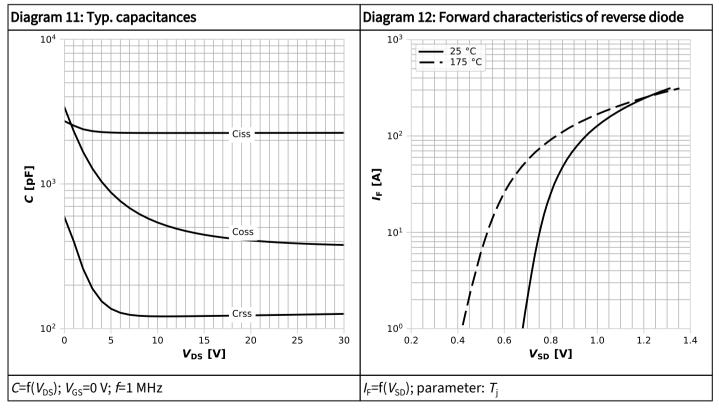




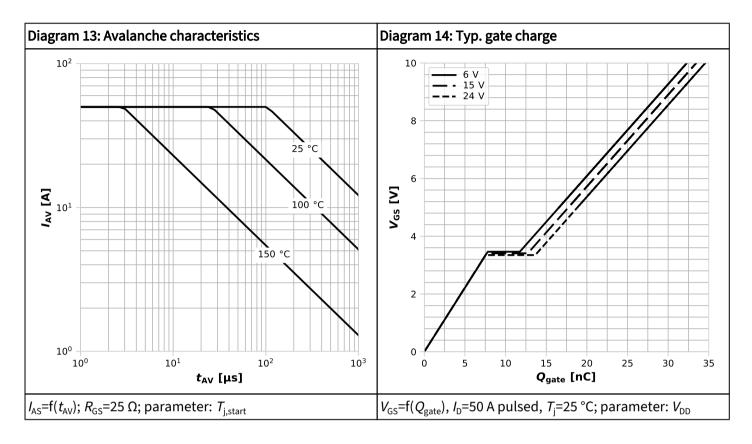


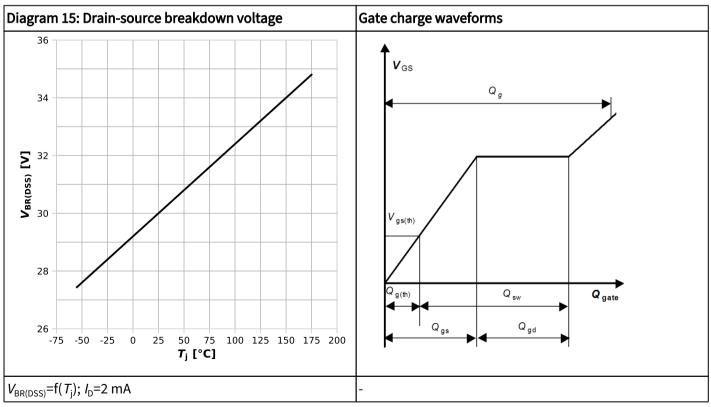














5 Package Outlines

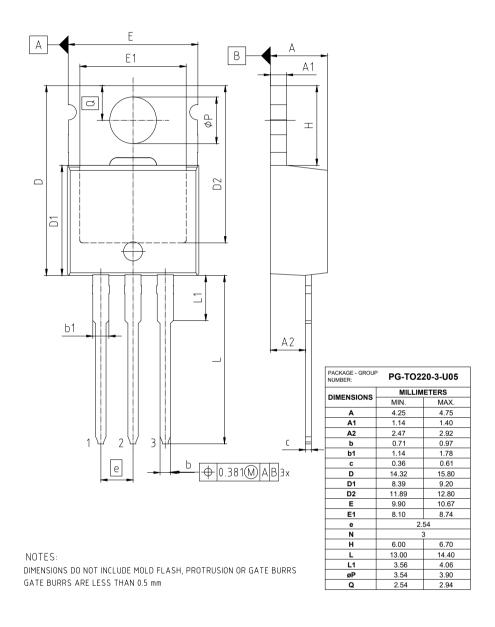


Figure 1 Outline PG-TO220-3, dimensions in mm

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Revision History

IPP033N03LF2S

Revision 2024-05-23, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2024-05-23	Release of final			

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